

# Zynq UltraScale+ MPSoC

## OVERVIEW

Zynq® UltraScale+™ MPSoCs combine a high-performance Arm®-based multicore, multiprocessing system with ASIC-class programmable logic. These devices, equipped with dual- and quad-core application processors, deliver maximum scalability and are capable of offloading critical applications, such as graphics and video pipelining, to dedicated processing blocks, along with a full complement of integrated peripherals and connectivity cores suitable for next-generation systems.

Fully integrated programmable logic enables custom co-processors and custom memory hierarchies to meet application specific needs, including deep learning processing units (DPU) for AI/ML processing. The 16nm FinFET+ programmable logic communicates with the processing system through 6,000 interconnects, enabling bandwidth that is not possible with multichip solutions. Dramatic power savings are achieved through fine-grained control of power domains and gated power islands. With specialized processing elements for different workloads, Zynq UltraScale+ MPSoCs are optimal single-chip platforms for both cost-sensitive and high-performance applications.

## HIGHLIGHTS

### New ZU1 Device: Lowest-Cost, Lowest Power Entry Point

- > Same Arm Multiprocessing subsystem for portfolio scalability
- > 40% less static power than ZU2 device, with only 20% less programmable logic
- > Highest I/O-to-System Logic Cell ratio to maximize connectivity
- > Highest DSP-to-System Logic Cell ratio for maximum compute and AI offloading

### Packaging Innovation for Industry's Highest Compute Density

- > Integrated Fan-Out (InFO) packaging for ultra-compact form factor (9.5x15mm)
- > 60% less area (than flip-chip packaging) for better thermal & power distribution
- > 5X compute density vs comparable ASSPs (DMIPS/mm<sup>2</sup>)
- > Available for ZU1, ZU2, and ZU3 devices

### Architectural Advantages vs. ASSPs

- > Custom memory hierarchy for highest throughput, lowest latency designs
- > Tightly coupled memory enables full isolation of safety critical functions
- > Soft co-processors for offloading or extra processing capability
- > AI/ML processing capable with custom deep learning processing units (DPU)
- > Scalable with the full Zynq MPSoC portfolio – preserve your design investment



## TARGET APPLICATIONS

### Industrial

- > Machine Vision
- > Industrial Networking (Time-Sensitive Networking)
- > Industrial Controllers
- > Retail Analytics
- > Robotics
- > Drives

### Medical

- > Portable and Desktop Ultrasound
- > External Defibrillators
- > Endoscopy

### Automotive

- > Monitoring Systems
- > Front Camera Drivers Assist Systems

### AV Broadcasting

- > Portable Pico Projectors
- > Small Form Factor Broadcast

### Aerospace & Defense

- > MILCOM Radio
- > Missiles & Munitions

## FEATURES

	CG Devices	EG Devices	EV Devices
<b>PROCESSING SYSTEM</b>			
Application Processing Unit	Dual-core Arm® Cortex®-A53	Quad-core Arm Cortex-A53	Quad-core Arm Cortex-A53
Real-Time Processing Unit	Dual-core Arm Cortex-R5F	Dual-core Arm Cortex-R5F	Dual-core Arm Cortex-R5F
Graphics Processing Unit	–	Arm Mali™-400 MP2	Arm Mali-400 MP2
Video Codec Unit	–	–	Up to 8K @ 15fps Supports H.264/H.265
Embedded and External Memory	256KB On-Chip Memory w/ECC; External DDR4/3/3L; LPDDR4/3; External Quad-SPI; NAND; eMMC		
<b>PROGRAMMABLE LOGIC*</b>			
System Logic Cells (K)	600	1,143	504
DSP Slices	2,520	3,528	1,728
Transceivers	24 @ 16Gb/s	44 @ 16Gb/s 28 @ 32Gb/s	24 @ 16Gb/s
On-Chip Memory (Mb)	44.2	80.4	44.2
PCIe® Gen3 x16	2	5	2
100G Ethernet Blocks with RS-FEC	–	4	–
150G Interlaken	–	4	–
<b>FEATURES OVERVIEW</b>			
Dynamic Power Management	<ul style="list-style-type: none"> <li>&gt; Multiple power domains with granular gating control</li> <li>&gt; Platform Management Unit for power, safety, and reliability</li> </ul>		
Safety and Security	<ul style="list-style-type: none"> <li>&gt; Configuration Security Unit for anti-tamper and lockdown</li> <li>&gt; Support for 4096-bit RSA keys with SHA-3 hash functions</li> <li>&gt; Secure system boot with AES 256 decryption</li> <li>&gt; Full Arm TrustZone support</li> </ul>		
Custom Memory Hierarchy	<ul style="list-style-type: none"> <li>&gt; Up to 10MB of internal local memory for co-processors and custom accelerators</li> <li>&gt; Multiple DDR controller capable for lowest latency memory access</li> <li>&gt; Tightly coupled memory enables isolated design flows for safety-critical applications</li> </ul>		
Deep Learning Processing Unit (DPU) Compatible	<ul style="list-style-type: none"> <li>&gt; Configurable computation engine dedicated to convolutional neural networks</li> <li>&gt; Accelerate AI/ML functions easily with reference designs and pre-built AI models</li> </ul>		

\*Maximum for each device family

## TAKE THE NEXT STEP

Zynq UltraScale+ MPSoCs are supported by comprehensive development tools, reference designs, an IP catalog, and evaluation platforms. For more information about Xilinx Zynq UltraScale+ MPSoCs, visit <https://www.xilinx.com/zynq-ultrascale-plus.html>. Evaluation kits sold separately; see the [Zynq UltraScale+ MPSoC Kit Selection Guide](#) for details and place an order today.

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